

SDLS058

SN54157, SN54LS157, SN54S157, SN54S158,
SN74157, SN74LS157, SN74S158, SN74S157, SN74S158
QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MUXES

MARCH 1974 - R VISE:J MARCH 1988

- Buffered Inputs and Outputs
- Three Speed/Power Ranges Available

TYPES	TYPICAL AVERAGE PROPAGATION TIME	TYPICAL POVIEA DISSIPATION
'157	9 ns	1.1QmW
'LS157	9 n•	49mW
'5157	5 m	250mW
'LS158	7 n>	24mW
'5158		19SmW

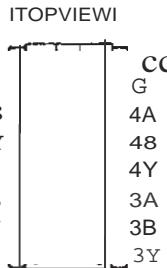
applications

- Expand Any Data Input Point
- Multiplex Dual Data Buses
- Generate Four Functions of Two Variables (One Variable Is Common)
- Source Programmable Counters

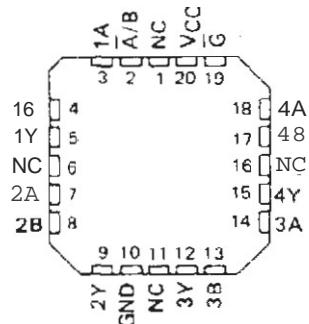
description

These monolithic data selector/multiplexers contain inverters and drivers to supply full on-chip datal se Ection to the four output gates. A separate strobe input is provided. A 4-bit word is selected from one of two sources and is routed to the four outputs. The '157, 'LS157, and 'S157 present true data whereas the 'LS158 and 'S158 present inverted data to minimize propagation delay time.

SN54157, SNS4LS157, SN54S157,
SN54S158, SN54S158 . . . J OR W PACKAGE
SN74157 . . . N PACKAGE
SN74LS157, SN74S157 . . .
SN74S158, SN74S158 . . . DOR N PACKAGE



SN541S157, SN54S157, SN54S158,
SN54S158 . . . FK PACKAGE jTOP
VIEW)



NC - No internal connection

FUNCTION TABLE

TAOEE ! G	SELECT A IB	INPUTS		OUTPUT Y	
		A	B	'157	'LS1S8 '157, 'S157 • 'S158
X	X	X	I	L	H
L	L	X	I	L	H
L	H	X	I	H	L
H	X	L	I	L	H
H	X	H	I	H	L

H = high level, L = low level, X = irrelevant

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, Vee (See Note 1)	7V
Input voltage: '157, '5158	5.5 V
'LS157, 'LS158	7 V
Operating free-air temperature range: SN54'	-55°C to 125°C
SN 74'	0°C to 70°C
Storage temperature range	-65°C to 150°C

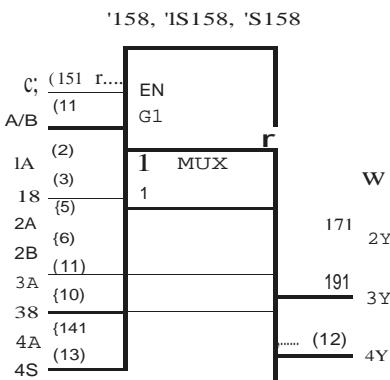
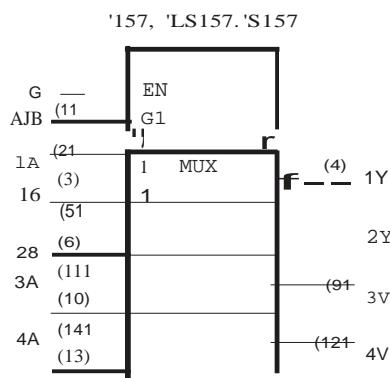
NOTE 1: Voltage values are with respect to net work ground terminal.

PR0011: UAT0 . . .oots CMeir int. . etan
currut . . . of Moblicatidate.Pr""cts COifw u
Of'Cf<eliOOI — t... lrlill& of Touo lootIIIIfit
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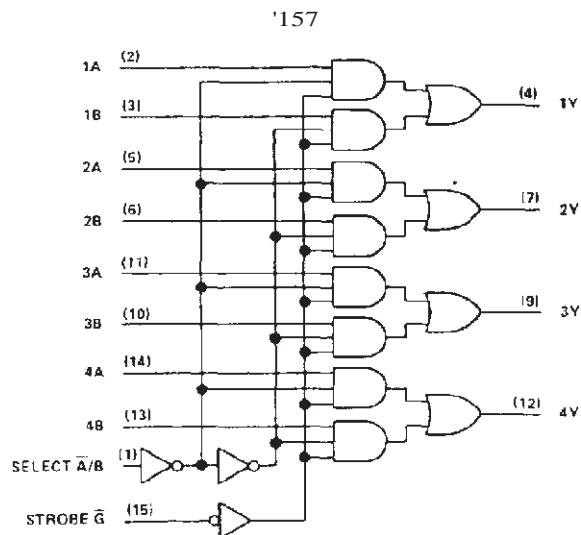
**TEXAS
INSTRUMENTS**

SN54157, SN54LS157, SN54LS158, SN54S157, SN54S158,
 SN74157, SN74LS157, SN74IS158, SN74S157, SN74S158
 OUAOHUPLE 2-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS

logic symbols¹

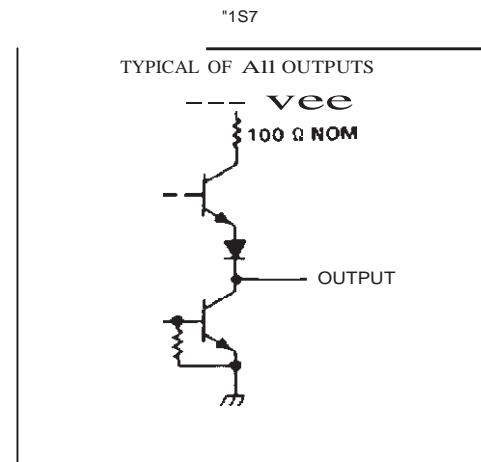
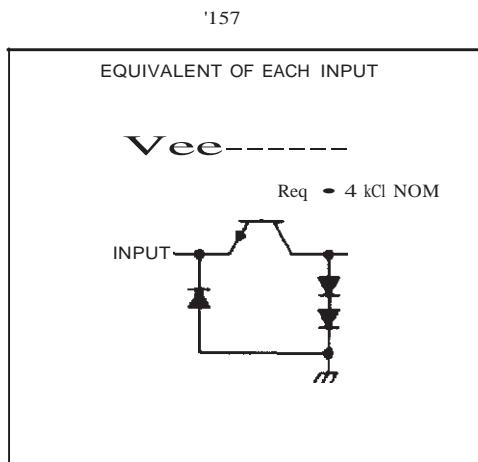


logic diagram (positive logic)



¹These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs

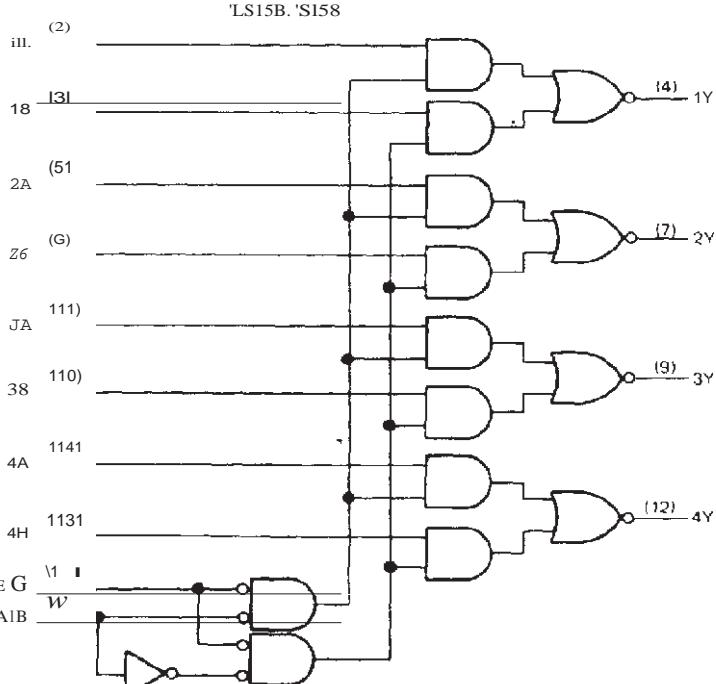
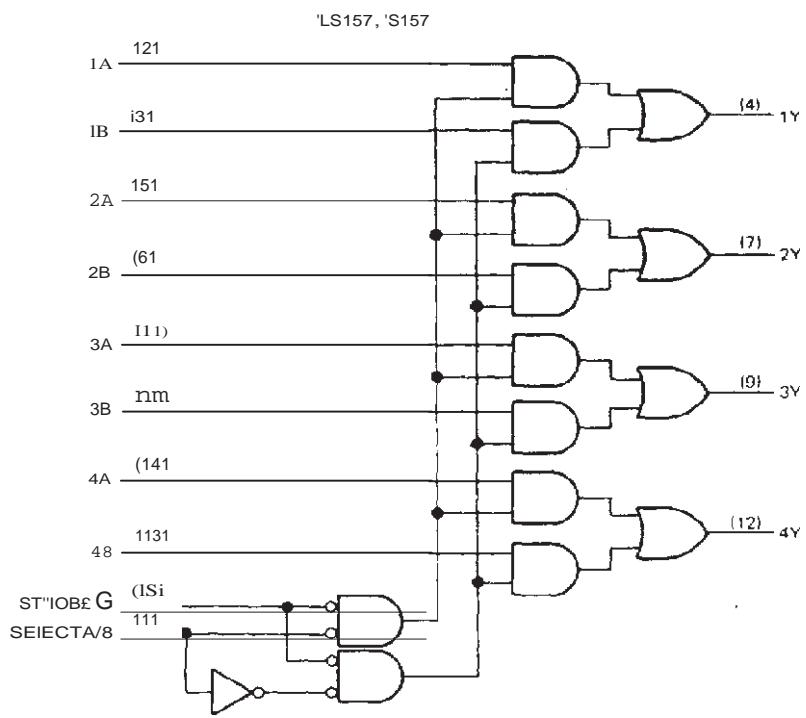


TEXAS
INSTRUMENTS

O11 U157ICF8(X TJ.TJ'2 + 0A.U.A.S, TEXAS 15Z65

SN54LS157, SN54LS158, SN54S157, SN54S158,
SN74LS157, SN74LS158, SN74S157, SN74S158
QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MUXES

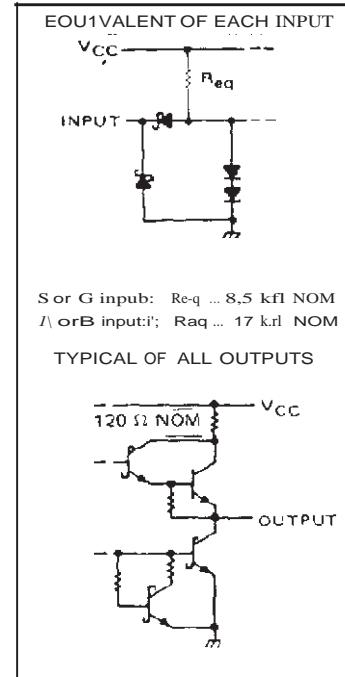
logic diagrams (positive logic)



Pjn nombt3 shall Vn are for D, J, N, and W pack Qes.

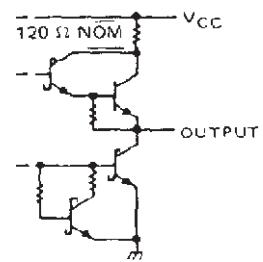
schematics of inputs and outputs

'LS157, 'LS158



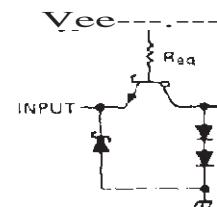
S or G input: R_{eq} ... 8.5 kΩ NOM
J or B input: I_{in}; R_{eq} ... 17 kΩ NOM

TYPICAL OF ALL OUTPUTS



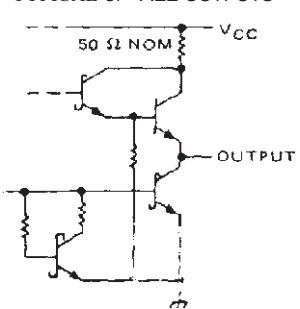
'S157, 'S158

EQUIVALENT OF EACH INPUT



S or G input: A₉₀ ~ 1.4 kΩ NOM
A or B input: R_{eq} ~ 2.8 kΩ NOM

TYPICAL OF ALL OUTPUTS



**TEXAS
INSTRUMENTS**

PQ-ST OFF:ct 80X 555012 • DALLAS, TEXAS 75255

SN54157, SN74157
QUADRUPLE 2-LINE TO t-UNE DATA SELECTORS/MUXERS

recommended operating conditions

	SN54157			SN74157			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{ee}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I _{OH}		-BOO		-800		-800	fA
Low-level output current, I _{OL}		16		16		16	mA
Operating free air temperature, TA	-55	125	0	0	70	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS ¹	SN 5 4 15 7			SN 7 4 15 7			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
High-level input voltage		2			2			V
V _{I1} Low-level Input voltage			0.8			0.8		V
V _{IK} Input clamp voltage	V _{ee} MIN, I _I = 12 mA		1.5			..1.5		V
V _{OH} High-level output voltage	V _{ee} MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, IOH = -800 mA	2.4	3.4		2.4	3.4		V
V _{OL} Low-level output voltage	V _{ee} MIN, V _{IH} = 2 V, V _{IL} = 0.4 V, IOL = 16 mA	0.2	0.4		0.2	0.4		V
I _{I1} Input current at minimum input voltage I _{IIH} High-level output current	V _{ee} MAX, V _I = 5.5 V V _{ee} MAX, V _I = 2.4 V		40			40		mA
I _{IL} Low-level output current	V _{ee} MAX, V _I = 0.4 V		1.6			1.6		..A
I _{1_9} Short-circuit Output Current	V _{ee} MAX	-20	-55	-18	55			mA
I _{CC} Supply current	V _{ee} MAX. See Note 2	30	48	30	48			mA

¹For condition-f. & when A & M_{DN} or MAX. use the appropriate value specified under test condition noted at the condition.

All typical values are at V_{ee} = 5 V, TA = 25°C.

Not more than one output should be shorted at a time and duration of short-circuit not exceeded one second.

NOTE 2: I_{CC} is measured at 4.5 V applied 10 Hz input, and a 100 pF output capacitor.

switching characteristics, V_{ee} = 5 V, TA = 25°C

PARAMETER ¹	FROM (INPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
			9	14	s	
I _{PLH}	Data		9	14		
I _{PHL}			1J	20		
I _{PLH}	Strobe G		14	21		
I _{PHL}			15	23		ns
I _{PLH}	Select A:tB		18	27		

¹t_{PLH} = propagation delay time, low-to-high-level output

I_{PHL} = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1

TEAS
INSTRUMENTS

POST OFFICE BOX 635012 • DALLAS, TEXAS 75205

SN54LS157, SN54LS158, SN74LS157, SN74LS158
QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MUXES

recommended operating conditions

	PARAMETER	SN54LS'			SN74LS'			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Vee	SUPPLY voltage	4.5	5	5.5	4.75	5	5.25	V
IoH	Highest-level output current			-400			-400	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55	125	0	0	70	"C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54LS'			SN74LS'			UNIT	
		MIN	TYP:	MAX	MIN	TYP:	MAX		
VIH	High-level input voltage	2			2			V	
vIL	Low-level input voltage			0.7			0.8	V	
viK	Input clamp voltage	VeeMIN, $t=18\text{mA}$			-1.5		-1.5	V	
VoH	High-level output voltage	Vee MIN, $V_{TH} = 2V$, $I_{OH} = 400\mu\text{A}$	2.5	3.4	2.7	3.4		V	
vOH	Low-level output voltage	VeeMIN, $V_{IH} = 2V$, $I_{OL} = 4\text{mA}$ VeeMAX, $I_{tot} = 8\text{mA}$	0.25	0.4	0.25	0.4		V	
II	Input current at maximum input voltage	AIB or G			0.2		0.2		
		A orB	VeeMAX, $V_I = 7\text{V}$		0.1		0.1	mA	
ItH	High-level input current	A/B or G			40		40	uA	
		A orB	VeeMAX, $V_I = 2.1\text{V}$		20		20		
ItL	Low-level input current	AIB or G			-0.8		-0.8	mA	
		A orB	Vee= MAX, $V_I = 0.4\text{V}$		-0.4		-0.4		
IS	Short-circuit output current	Vee=IAX			-20	-100	-20	mA	
Iee	Supply current	Vee MAX, See Note	'LS157	9.7	16	9.7	16		
			'LS158	4.8	8	4.8	8	H	
		VeeMAX, All A inputs at 4.5 V, All other inputs at 0 V	'LS158	6.5	11	6.5	11		mA

¹ For cond110r"5s.ho!Nr. ;;M•N or MAX. Use the appropriate Vee & supply voltage under 1" & recommended operating conditions.
+All two cal values are at VCC .. V. TA .. 25°C.

\$Note more than one output can be driven at a time and duration of short circuit should not exceed one second.
NOT 2 ICC time limit W1th 4.5 V 21ppfied to all inputs and all outputs open.

switching characteristics, $Vee = 5\text{V}$, $TA = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TEST CONDITIONS	'LS157			'LS156			UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX		
tPLH	Data	CL = 15pF, RL = 2 kΩ, See Note 3	9	14		7	12		ns	
			9	14		10	15			
			13	20		11	17			
	Strobe G		14	21		18	24		ns	
			15	23		13				
			18	27		16	2			
IPLH	Select A/B								ns	

IPLH = propagation delay time, low-to-high-level output

IPHI = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage diagrams are shown in Section I

**TEXAS.
INSTRUMENTS**

POST OFFICE BOX 655011 • OAKLAND, CALIFORNIA 94516

SN54S157, SN54S158, SN74S157, SN74S158 QUADRUPLE 2-LINE TO 1-LINE DATA SELECTORS/MUXES

recommended operating conditions

	SN54S157 SN54S158			SN74S157 SN74S158			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{ee}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I _{OH}		-1			-1		mA
Low-level output current, I _{OL}		20			20		mA
Operating free-air temperature, TA	-55	125	0	0	70	0	C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54S157			SN74S158			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
V _H High-level input voltage		2		2				V
V _L Low-level input voltage			0.8			0.8		V
V _{iK} Input clamp voltage	V _{ee} MIN, I _L =-18mA		-1.2			-1.2		V
V _{OH} High level output voltage	V _{ee} > MIN, V _{IH} 2V, V _{tL} = 0.8 V, I _{OH} = -1 mA !Serial < 74S	2.5	3.4		2.5	3.4		V
V _{OL} Low-level output voltage	V _{ee} MIN, V _{tH} =2V, V _L = 0.8 V, I _{OL} = 20 mA		0.5			0.5		V
Input current at maximum input voltage	V _{ee} • MAX, V _t = .5V							
I _{tH} High-level input current	A1B or G A or B	V _{ee} < I _{tX} , V _t =27V	100		100			A
I _{tL} Low-level input current	A1B or G	V _{ee} • MAX, V _t = 0.5 V	-4		-4			mA
A o. B			-2		-2			
I _{OS} Short-circuit output current	V _{ee} = MAX V _{ee} = MAX, All inputs 1.4 V.	40	100	-10	-100			mA
I _{ee} Supply current	See Note 2 V _{ee} = MAX, A inputs at 4.5 V.		50	78	39	61		mA
						81		
B,G,S, input at 0 V. See Note 2								

:For conditions, see Note 1. MIN or MAX, use thP. iJpprrnni H! vaJuf! spP.cifP--d undPr rer.nrnmp.nded operating conditions.

0.1 typical values are at V_{ee} = 5 V, TA = 25°C.

NOTE more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second,

Note 2: I_{cc} is measured with all outputs open.

Switching characteristics, V_{ee} = 5 V, TA = 25°C

PARAMETER	FROM (INPU _n)	TEST CONDITIONS	SN54S157		SN54S158		UNIT
			MIN	TYP	MA)(MIN	
t _{PLH}	Dato		5	7.5		4	6
t _{PHL}			4.5	6.5		4	6
t _{IPLH}	Strobe G	CL= 151-1f, RL = 2BOII, See Note 3	8.5	12.5		6.5	11.5
t _{IPH}			7.5	12		7	12
t _{If>LH}	Select A1B		9.5	15		8	12
t _{IfHL}			9.5	15		B	12

t_{PLH} = propagation delay time, low-to-high-level output

t_{PHL} = propagation delay time, high-to-low-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section

Text...:-
INSTR...: ¥1£1'-ITS

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
76002012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07904BEA	OBsolete	CDIP	J	16		TBD	Call TI	Call TI
JM38510/07904BFA	OBsolete	CFP	W	16		TBD	Call TI	Call TI
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S158J	OBsolete	CDIP	J	16		TBD	Call TI	Call TI
SN54S15J	OBsolete	CDIP	J	14		TBD	Call TI	Call TI
SN74157N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74157N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
SN74S158D	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158D	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S158FK	OBsolete	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S158J	OBsolete	CDIP	J	16		TBD	Call TI	Call TI
SNJ54S158W	OBsolete	CFP	W	16		TBD	Call TI	Call TI
SNJ54S15FK	OBsolete	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S15J	OBsolete	CDIP	J	14		TBD	Call TI	Call TI
SNJ54S15W	OBsolete	CFP	W	14		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

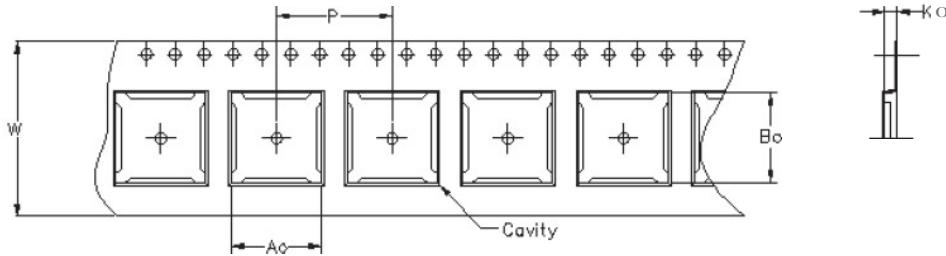
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

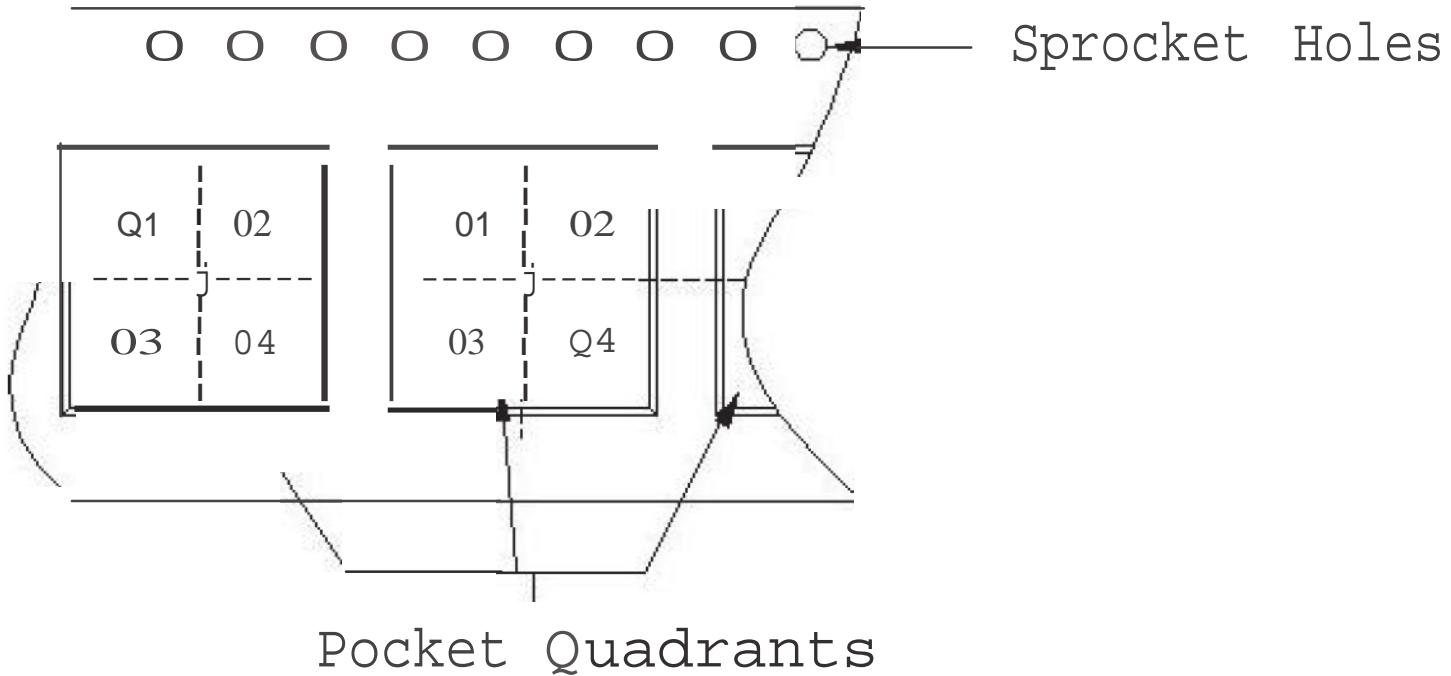
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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



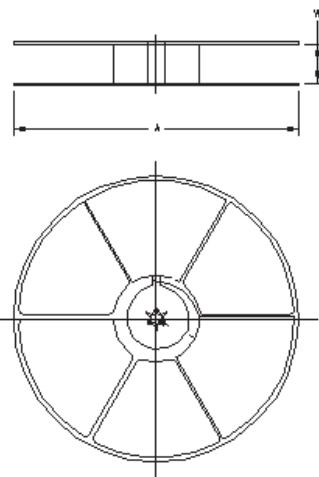
Carrier tape design 1s defined largely by the component length, width, and thickness.

A_0 = Dimension designed to accommodate the component width.
B_0 = Dimension designed to accommodate the component length.
K_0 = Dimension designed to accommodate the component thickness.
W = overall width of the carrier tape.
P = Pitch between successive cavity centers.



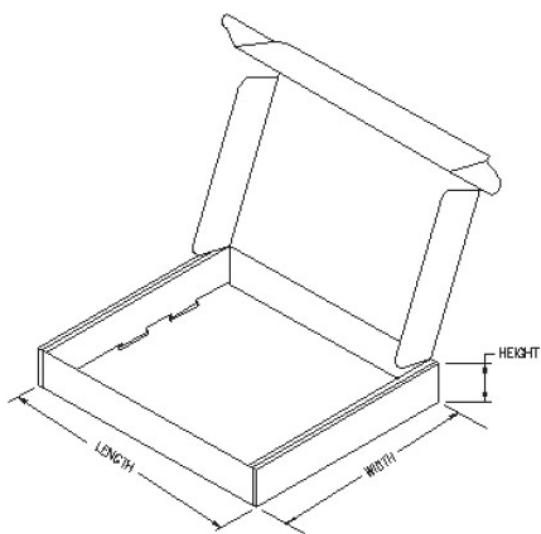
TAPE AND REEL INFORMATION

Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS157DR	D	16	FMX	330	16	6.5	10.3	2.1	8	16	Q1
SN74LS157NSR	NS	16	MLA	330	16	8.2	10.5	2.5	12	16	Q1
SN74LS158DR	D	16	FMX	330	16	6.5	10.3	2.1	8	16	Q1
SN74LS158NSR	NS	16	MLA	330	16	8.2	10.5	2.5	12	16	Q1
SN74S157NSR	NS	16	MLA	330	16	8.2	10.5	2.5	12	16	Q1



TAPE AND REEL BOX INFORMATION

Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74LS157DR	D	16	FMX	342.9	336.6	28.58
SN74LS157NSR	NS	16	MLA	342.9	336.6	28.58
SN74LS158DR	D	16	FMX	342.9	336.6	28.58
SN74LS158NSR	NS	16	MLA	342.9	336.6	28.58
SN74S157NSR	NS	16	MLA	342.9	336.6	28.58



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
76002012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76002012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7600201FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
76033012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
7603301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/07904BEA	OBsolete	CDIP	J	16		TBD	Call TI	Call TI
JM38510/07904BFA	OBsolete	CFP	W	16		TBD	Call TI	Call TI
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BEA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
JM38510/30903BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S158J	OBsolete	CDIP	J	16		TBD	Call TI	Call TI
SN54S15J	OBsolete	CDIP	J	14		TBD	Call TI	Call TI
SN74157N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74157N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157N3	OBsolete	PDIP	N	16	TBD		Call TI	Call TI
SN74LS157N3	OBsolete	PDIP	N	16	TBD		Call TI	Call TI
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
SN74LS158DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158DRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS158NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S157NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S157NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S157NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
SN74S157NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S158D	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158D	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158DR	OBsolete	SOIC	D	16		TBD	Call TI	Call TI
SN74S158N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SN74S158N3	OBsolete	PDIP	N	16		TBD	Call TI	Call TI
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS158W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S157W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S158FK	OBsolete	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S158J	OBsolete	CDIP	J	16		TBD	Call TI	Call TI
SNJ54S158W	OBsolete	CFP	W	16		TBD	Call TI	Call TI
SNJ54S15FK	OBsolete	LCCC	FK	20		TBD	Call TI	Call TI
SNJ54S15J	OBsolete	CDIP	J	14		TBD	Call TI	Call TI
SNJ54S15W	OBsolete	CFP	W	14		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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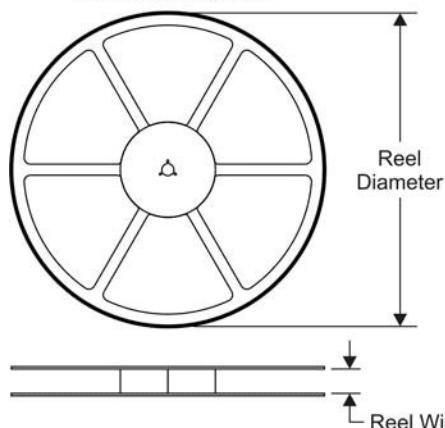
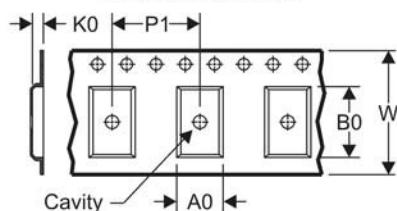
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54157, SN54LS157, SN54LS158, SN54S15, SN54S157, SN54S158, SN74157, SN74LS157, SN74LS158, SN74S157, SN74S158 :

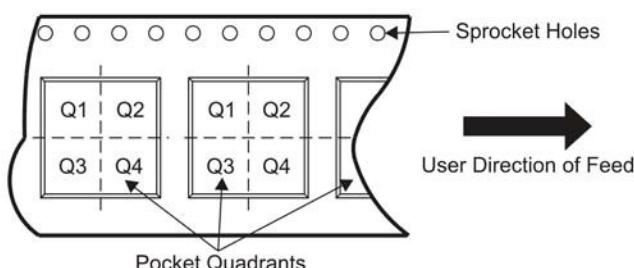
- Catalog: [SN74S15](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION
REEL DIMENSIONS

TAPE DIMENSIONS


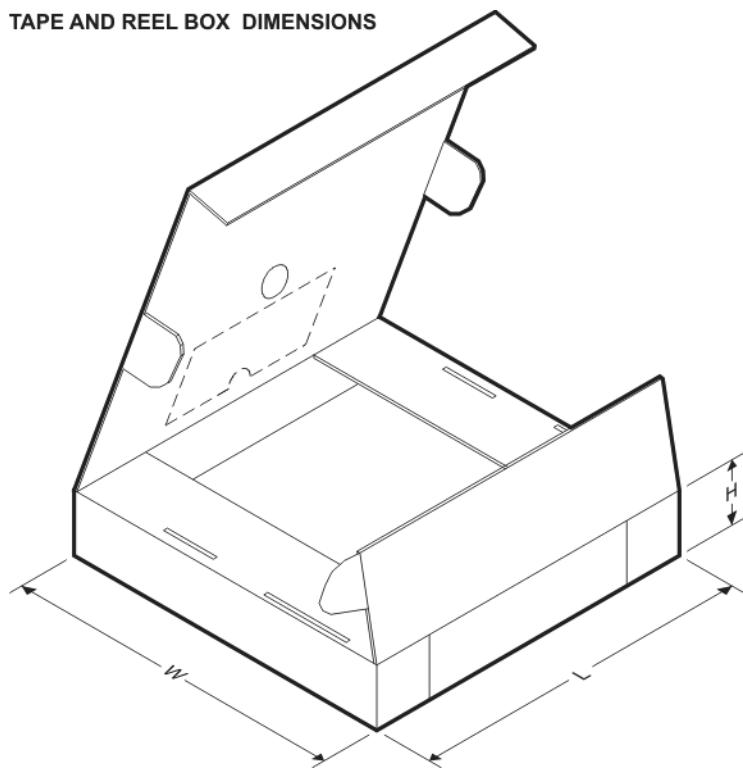
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS157DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS157NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS158DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS158NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74S157NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



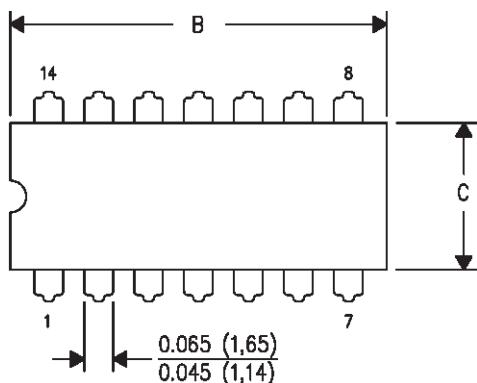
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS157DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS157NSR	SO	NS	16	2000	346.0	346.0	33.0
SN74LS158DR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS158NSR	SO	NS	16	2000	346.0	346.0	33.0
SN74S157NSR	SO	NS	16	2000	346.0	346.0	33.0

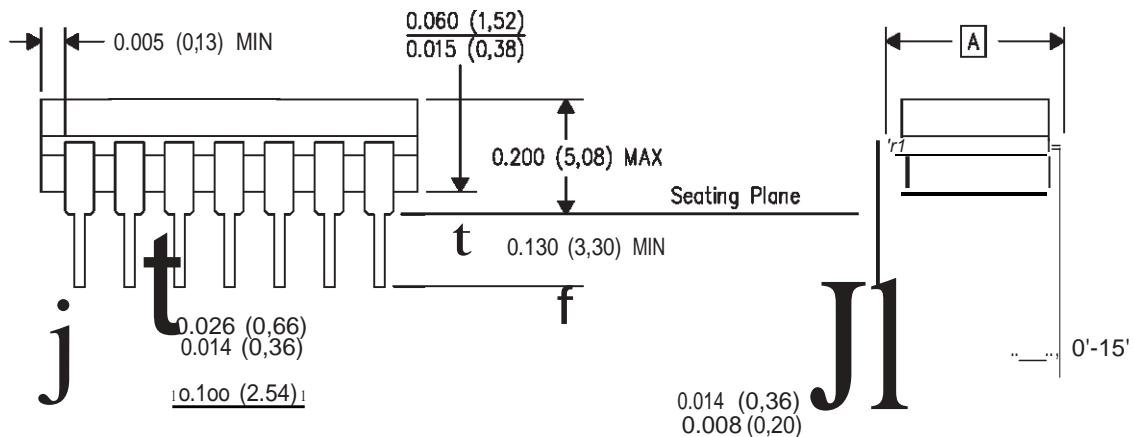
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



M	14	16	18	20
	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

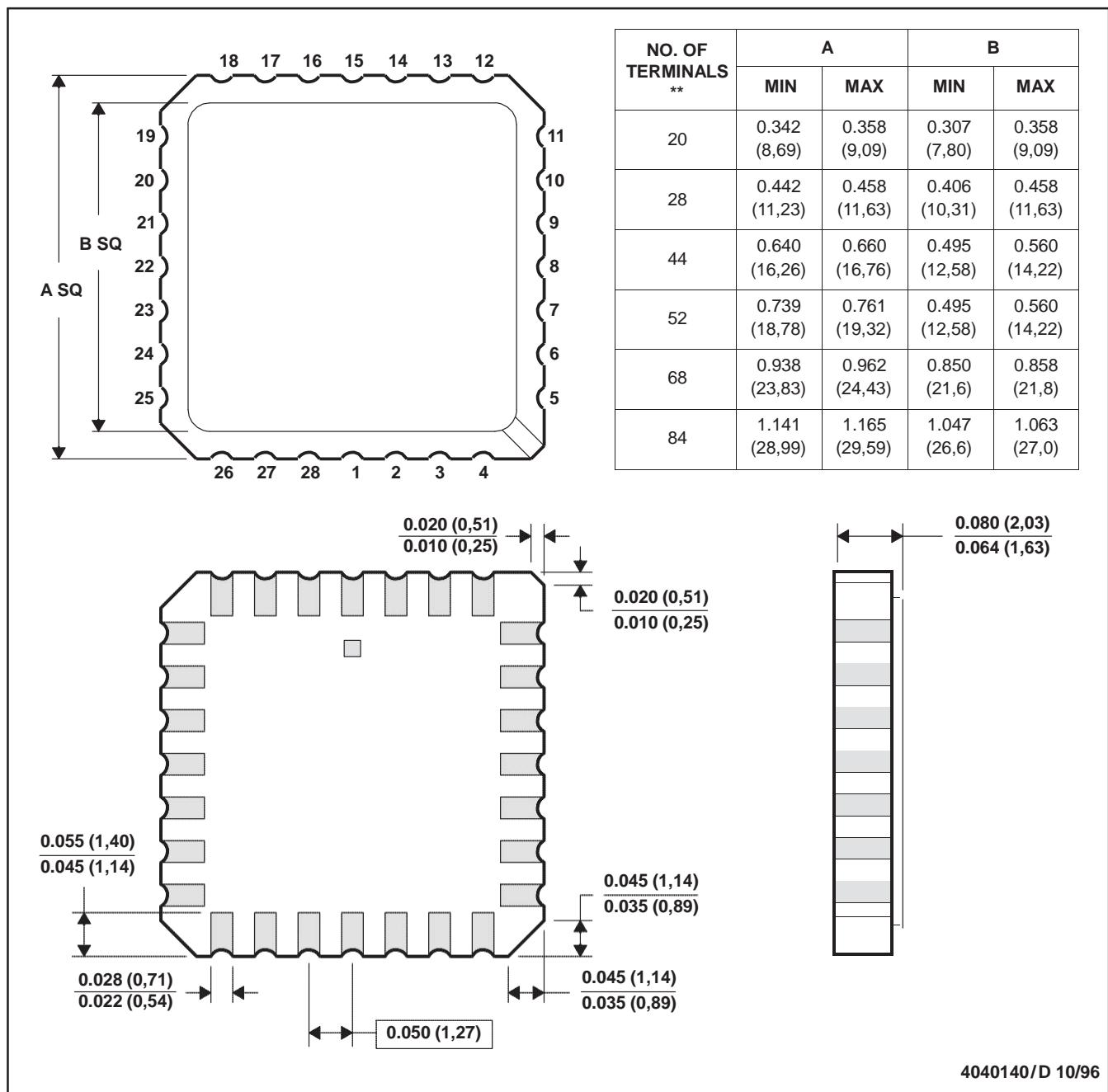
- NOTES:

 - A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL SID 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER

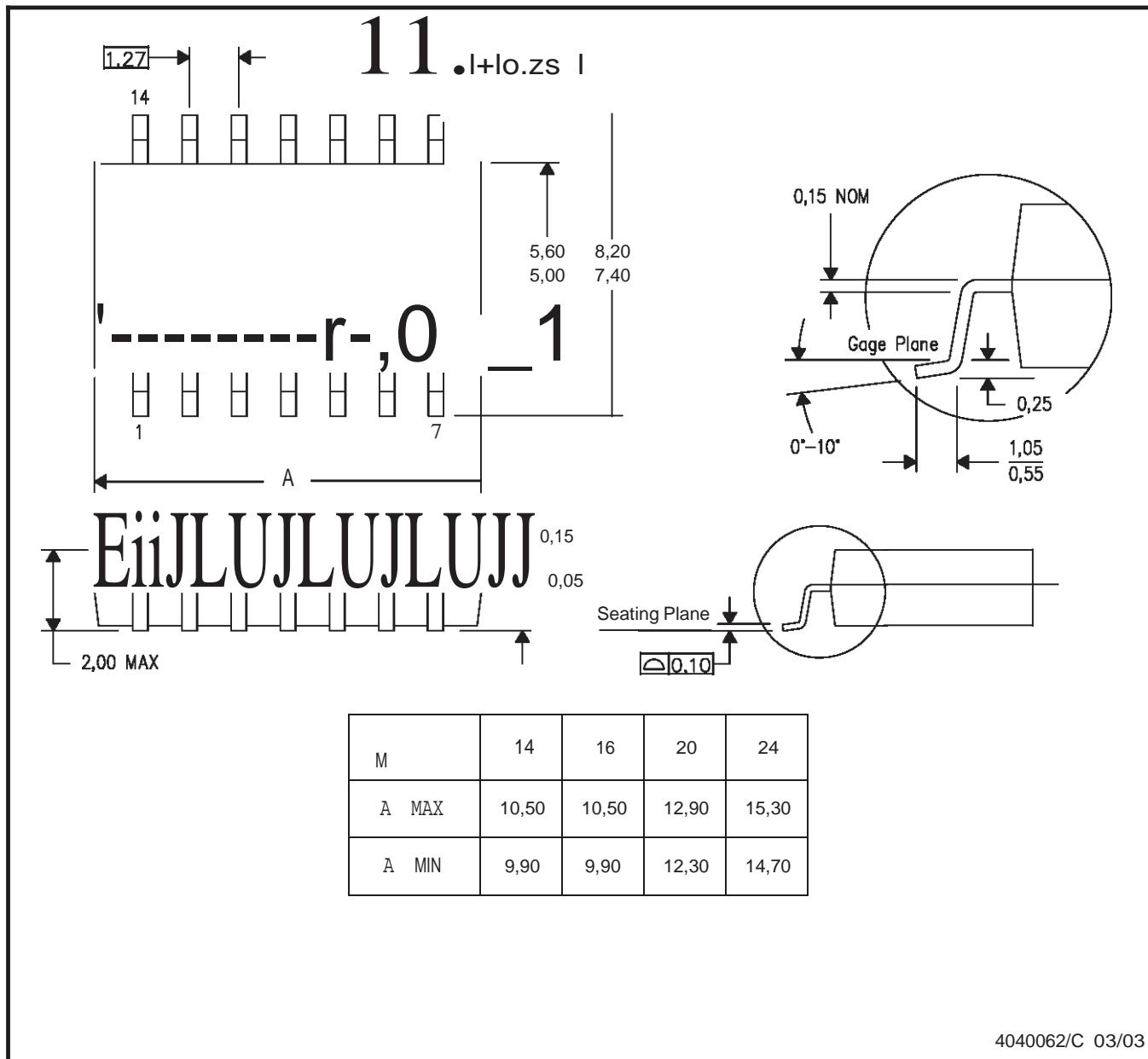


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within JEDEC MS-004

MECHANICAL DATA

NS(R-PDSO-G.,
14-PINS SHOWN

PLASTIC SMAU.-OUTUNE PACKAGE



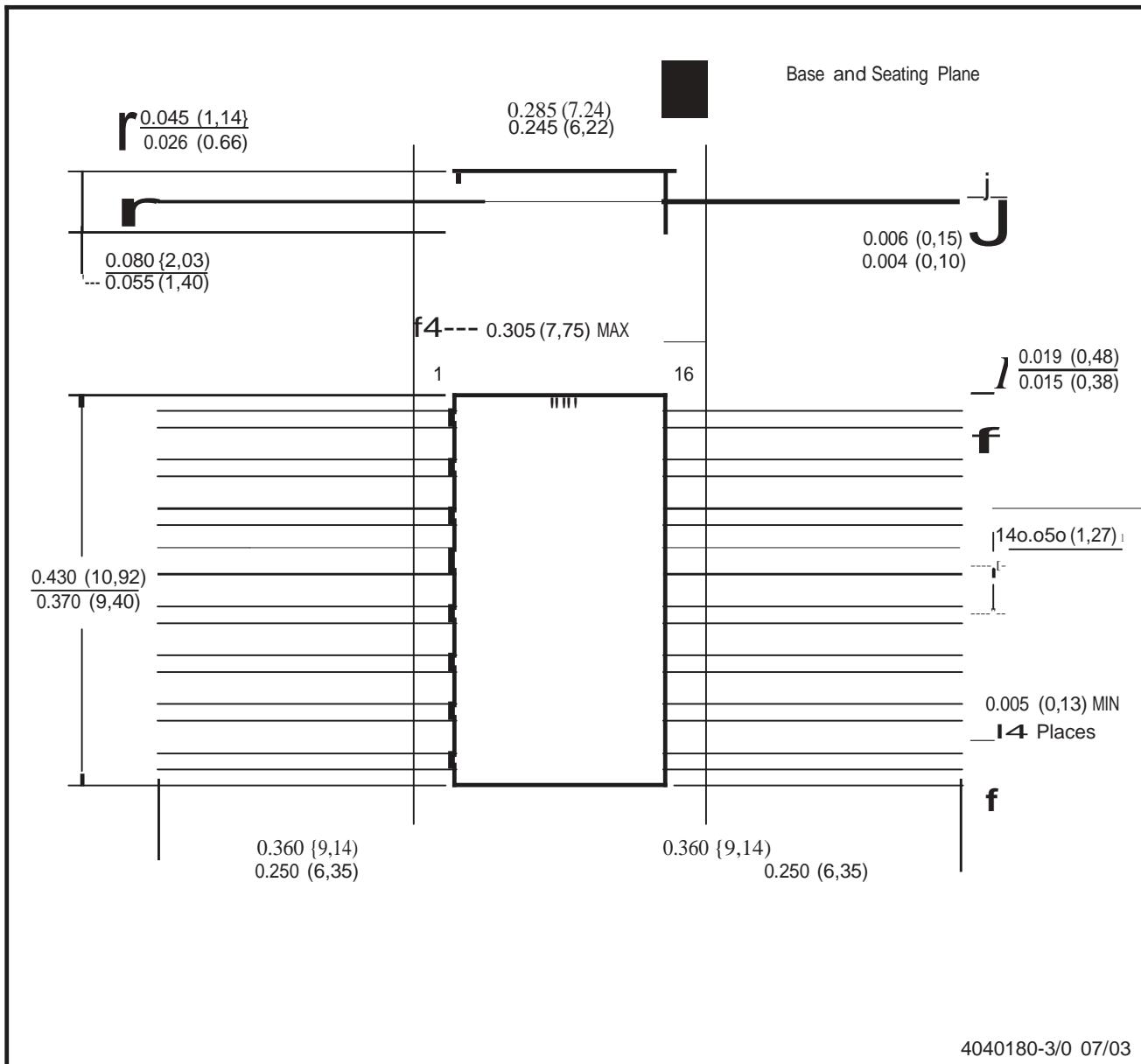
NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flush or protrusion, not to exceed 0,15.

4040062/C 03/03

MECHANICAL DATA

W (R-GDFP-F16)

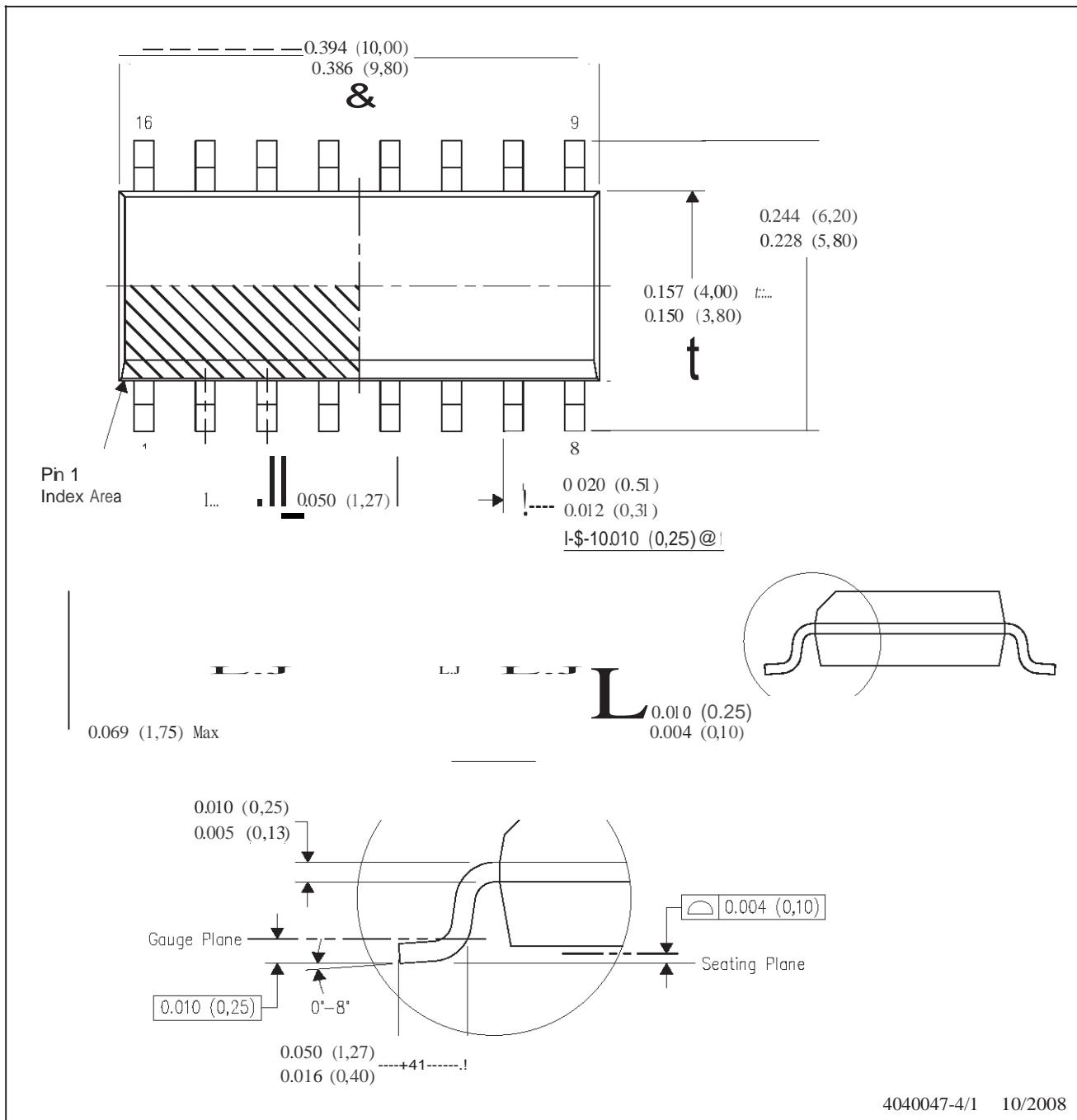
CERAMIC DUAL FLAIPACK



MECHANICAL DATA

0 (R-POSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (.015) per end.

£ Body width does not include interlead flash. Interlead flash shall not exceed .017 (0.43) per side.

E. Reference JEDEC MS-012 variation AC.

TEXAS
INSTRUMENTS
www.tl.com

D(R-PDSO-G16)

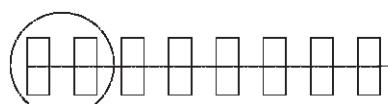
Example Board Layout
(Note C)

18HJ00000&0121 1

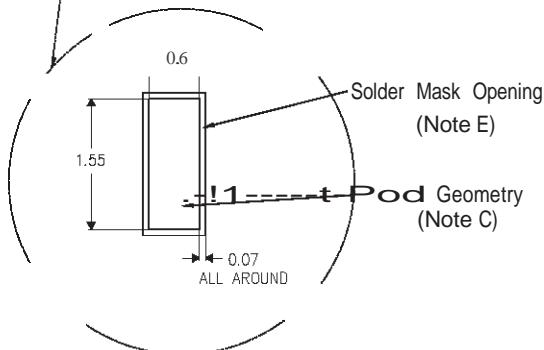
Stencil Openings
(Note D)

r]f0'D D D D 00 121 |

5.40



Non Solder Mask Define Pod



DDDDDDDD

T

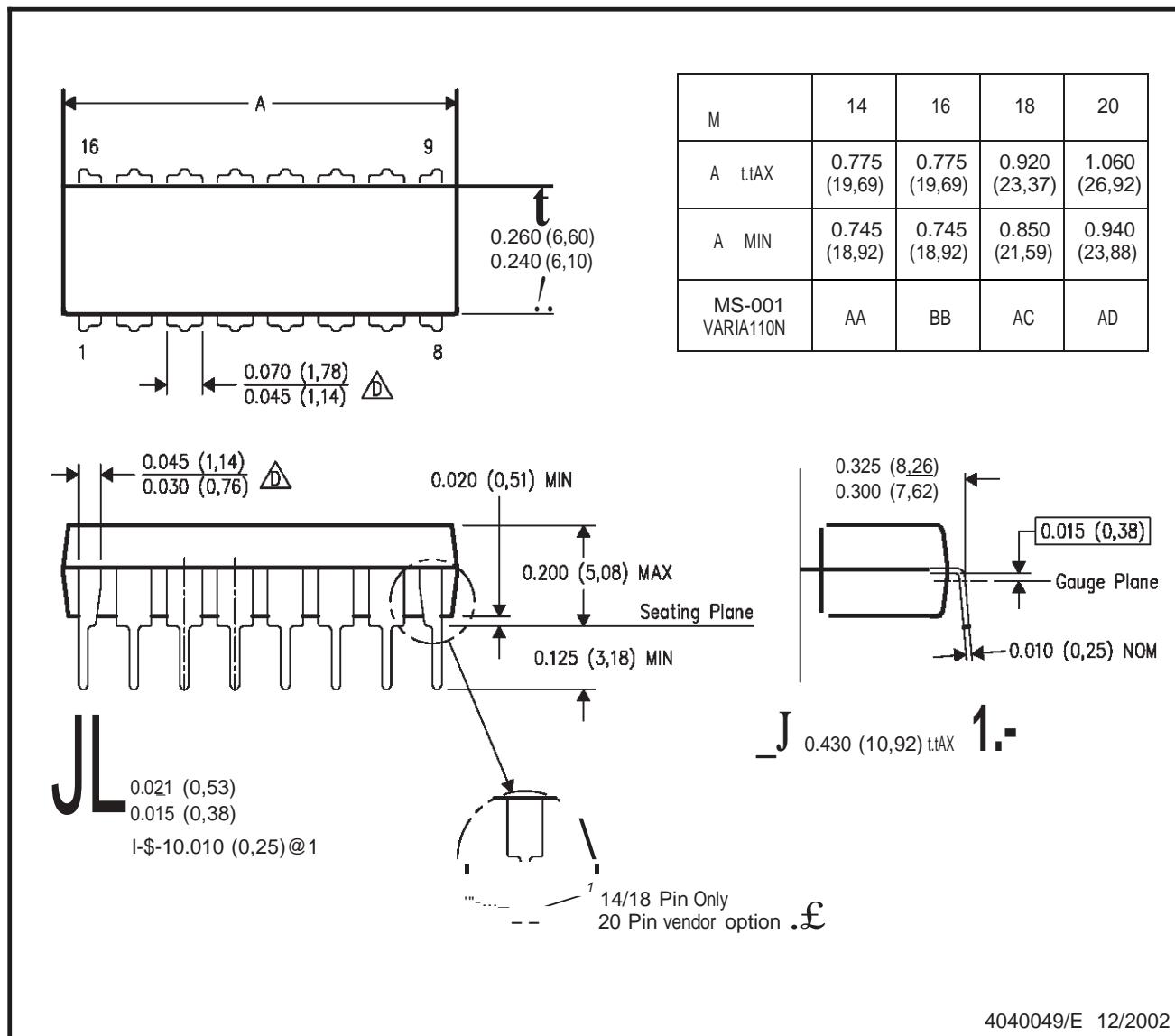
4209373/A 03/08

- N01ES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Refer to IPC7351 for alternate board design.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pods.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



4040049/E 12/2002

NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Lfu. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

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